## **Transistors**

# 2.5V Drive Nch MOS FET **RJK005N03**

#### ●Structure

Silicon N-channel MOS FET

#### ● Features

- 1) Low On-resistance.
- 2) Low voltage drive (2.5V drive).

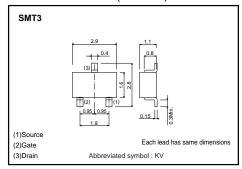
#### Applications

Switching

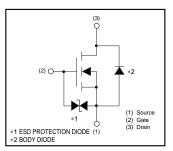
## ●Packaging specifications and hFE

	Package	Taping
Type	Code	T146
	Basic ordering unit (pieces)	3000
RJK005N03		0

## ●External dimensions (Unit : mm)



#### ●Inner circuit



## ● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit	
Drain-source voltage		VDSS	30	V	
Gate-source voltage		Vgss	±12	V	
Danie august	Continuous	ID	±500	mA	
Drain current	Pulsed	I <sub>DP</sub> *1	±2.0	Α	
Source current	Continuous	Is	200	mA	
(Body Diode)	Pulsed	Isp *1	800	mA	
Total power dissipation		P <sub>D</sub> *2	200	mW	
Channel temperature		Tch	150	°C	
Range of storage temperature		Tstg	-55 to +150	°C	

## ●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	625	°C/W

\* Each terminal mounted on a recommended land



<sup>\*1</sup> Pw≤10μs, Duty cycle≤1% \*2 Each terminal mounted on a recommended land

## ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	-	-	±10	μΑ	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR)</sub> DSS	30	-	-	V	I <sub>D</sub> = 1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	-	1	μΑ	Vps= 30V, Vgs=0V
Gate threshold voltage	V <sub>GS (th)</sub>	0.8	-	1.5	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Static drain-source on-state resistance		_	400	580	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 4.5V
	RDS (on)*	_	420	600	mΩ	Ip= 500mA, Vgs= 4V
		-	650	940	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 2.5V
Forward transfer admittance	Y <sub>fs</sub> *	0.5	-	-	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 500mA
Input capacitance	Ciss	_	60	-	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	-	24	_	pF	V <sub>G</sub> s=0V
Reverse transfer capacitance	Crss	-	12	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	9	-	ns	V <sub>DD</sub> ≒ 15V
Rise time	tr *	-	11	_	ns	ID= 250mA
Turn-off delay time	t <sub>d (off)</sub> *	-	16	_	ns	Vgs= 4V RL=60Ω
Fall time	t <sub>f</sub> *	-	31	-	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	_	2.0	4.0	nC	V <sub>DD</sub> ≒24V
Gate-source charge	Q <sub>gs</sub> *	-	0.6	-	nC	V <sub>GS</sub> = 4V
Gate-drain charge	Q <sub>gd</sub> *	_	0.7	_	nC	I <sub>D</sub> = 500mA

<sup>\*</sup>Pulsed

## ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp*	-	_	1.2	V	Is= 500mA, Vgs=0V

<sup>\*</sup>Pulsed

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